



**THE DATASHEET OF
BYG24D-E3/TR**





Fast Avalanche SMD Rectifier



SMA (DO-214AC)



ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.5 A
V_{RRM}	200 V, 400 V, 600 V
I_{FSM}	30 A
I_R	1.0 μ A
V_F	1.25 V
t_{rr}	140 ns
E_R	20 mJ
T_J max.	150 °C
Package	SMA (DO-214AC)
Circuit configuration	Single

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated junction
- Low reverse current
- Soft recovery characteristics
- Fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
- Automotive ordering code P/NHE3 or P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-E3 - RoHS-compliant, commercial grade
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHE3_X - RoHS-compliant, and AEC-Q101 qualified
Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,...)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3, M3, HE3, and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	BYG24D	BYG24G	BYG24J	UNIT
Device marking code		BYG24D	BYG24G	BYG24J	
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Average forward current at $T_A = 65\text{ °C}$	$I_{F(AV)}$	1.5			A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	30			A
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1\text{ A}$, $T_J = 25\text{ °C}$	E_R	20			mJ
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150			°C



ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS	SYMBOL	BYG24D	BYG24G	BYG24J	UNIT
Minimum breakdown voltage	$I_R = 100\ \mu\text{A}$	V_{BR}	200	400	600	V
Maximum instantaneous forward voltage	$I_F = 1\ \text{A}$	$T_J = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	1.15		V
	$I_F = 1.5\ \text{A}$			1.25		
Maximum reverse current	$V_R = V_{RRM}$	$T_J = 25\text{ }^\circ\text{C}$	1		I_R	μA
		$T_J = 100\text{ }^\circ\text{C}$	10			
Maximum reverse recovery time	$I_F = 0.5\ \text{A}, I_R = 1.0\ \text{A}, I_{rr} = 0.25\ \text{A}$	t_{rr}	140			ns

Note

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	BYG24D	BYG24G	BYG24J	UNIT
Junction to case	$R_{\theta JC}$	25			$^\circ\text{C/W}$
Maximum thermal resistance, junction to ambient	$R_{\theta JA}^{(1)}$	150			$^\circ\text{C/W}$
	$R_{\theta JA}^{(2)}$	125			

Notes

(1) Mounted on epoxy-glass hard tissue 35 μm x 17 mm^2 cooper area per electrode

(2) Mounted on epoxy-glass hard tissue 35 μm x 50 mm^2 cooper area per electrode

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
BYG24D-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG24D-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG24DHE3_A/H ⁽¹⁾	0.064	H	1800	7" diameter plastic tape and reel
BYG24DHE3_A/I ⁽¹⁾	0.064	I	7500	13" diameter plastic tape and reel
BYG24D-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG24D-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG24DHM3_A/H ⁽¹⁾	0.064	H	1800	7" diameter plastic tape and reel
BYG24DHM3_A/I ⁽¹⁾	0.064	I	7500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

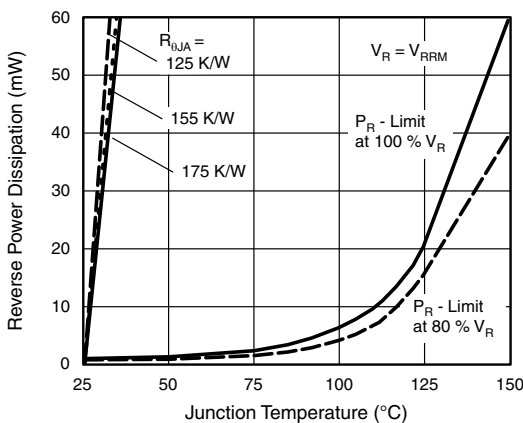


Fig. 1 - Max. Reverse Power Dissipation vs. Junction Temperature

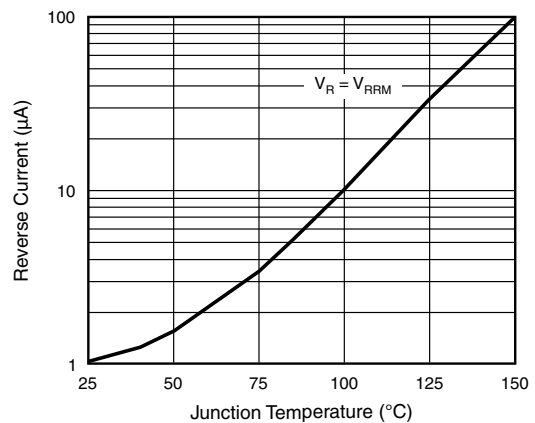


Fig. 2 - Reverse Current vs. Junction Temperature

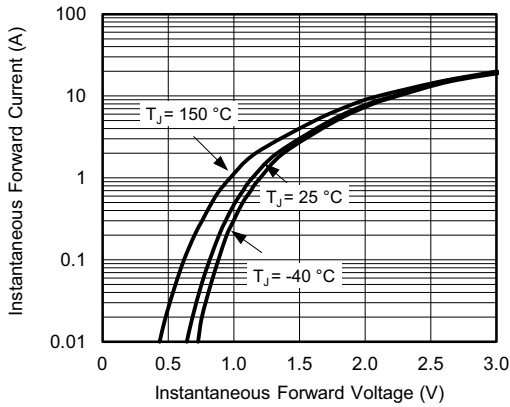


Fig. 3 - Forward Current vs. Forward Voltage

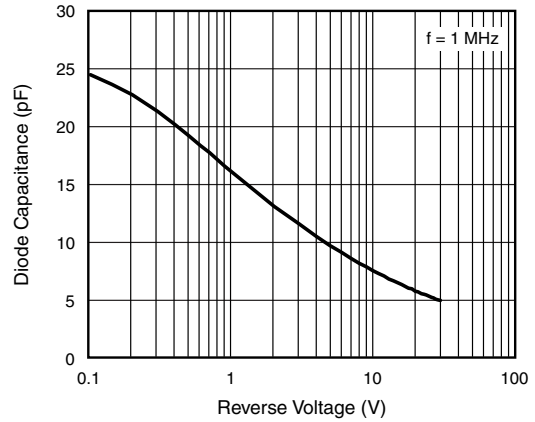


Fig. 5 - Diode Capacitance vs. Reverse Voltage

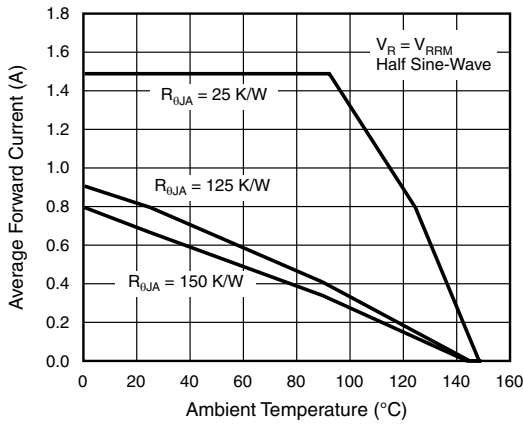
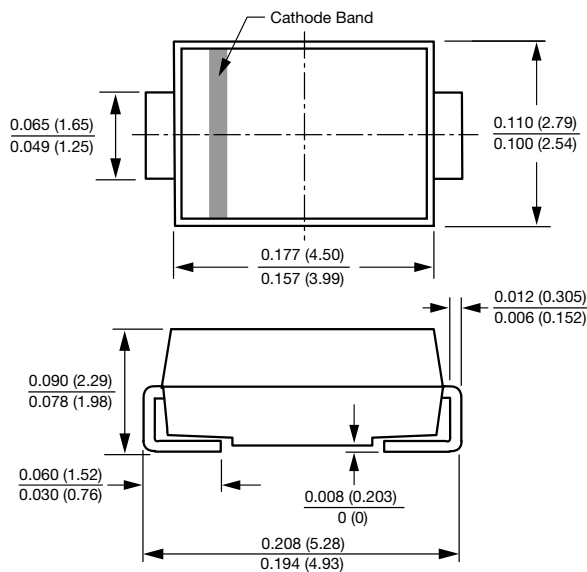


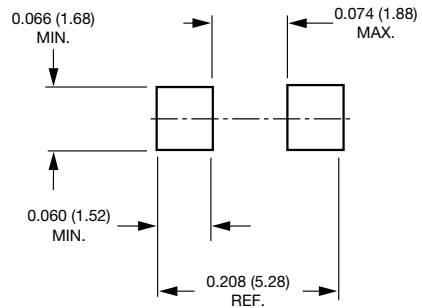
Fig. 4 - Average Forward Current vs. Ambient Temperature

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMA (DO-214AC)



Mounting Pad Layout





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